

# Description

The SJPX-H6 is a fast recovery diode of 600 V / 2.0 A. The maximum  $t_{rr}$  of 30 ns is realized by optimizing a life-time control.

#### **Features**

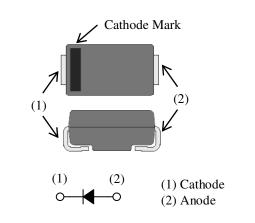
- Bare Lead Frame: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0
- Suitable for High Reliability and Automotive Requirement.

## Applications

• Freewheel Diode (Offline Buck Converter, Offline Buck-boost Converter, etc.)

# Package

SJP



Not to scale

## **Absolute Maximum Ratings**

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage	V <sub>RSM</sub>		600	V
Repetitive Peak Reverse Voltage	V <sub>RM</sub>		600	V
Average Forward Current	I <sub>F(AV)</sub>	See Figure 2 and Figure 3	2.0	А
Surge Forward Current	I <sub>FSM</sub>	Half cycle sine wave, positive side, 10 ms, 1 shot	20	А
I <sup>2</sup> t Limiting Value	I <sup>2</sup> t	$1 \text{ ms} \le t \le 10 \text{ ms}$	2.0	A <sup>2</sup> s
Junction Temperature	TJ		-40 to 150	°C
Storage Temperature	T <sub>STG</sub>		-40 to 150	°C

## Unless otherwise specified, $T_A = 25 \ ^{\circ}C$ .

# **Electrical Characteristics**

Unless otherwise specified, $T_A = 25 \ ^{\circ}C$ .						
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage Drop V <sub>F</sub>	V	$T_J = 25 \ ^{\circ}C, I_F = 2.0 \text{ A}$			1.5	V
	V <sub>F</sub>	$T_J = 100 \ ^{\circ}C, I_F = 2.0 \text{ A}$	_	1.1		V
Reverse Leakage Current	I <sub>R</sub>	$V_R = V_{RM}$	_	_	10	μA
Reverse Leakage Current under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150 \ ^\circ C$			3.0	mA
Reverse Recovery Time	t <sub>rr1</sub>	$I_F = I_{RP} = 100 \text{ mA},$ 90% recovery point, $T_J = 25 \text{ °C}$			30	ns
	t <sub>rr2</sub>	$I_{F} = 100 \text{ mA}, I_{RP} = 200 \text{ mA},$ 75% recovery point, $T_{J} = 25 \text{ °C}$	_		20	ns
Thermal Resistance <sup>(1)</sup>	R <sub>th(J-L)</sub>			_	20	°C/W

# **Mechanical Characteristics**

Parameter	Conditions	Min.	Тур.	Max.	Unit
Package Weight			0.072		g

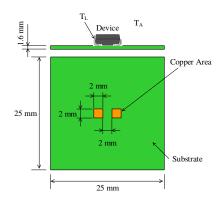


Figure 1. Lead Temperature Measurement Conditions

 $<sup>^{(1)}</sup>$  R<sub>th (J-L)</sub> is thermal resistance between junction and lead. Lead temperature (T<sub>L</sub>) is measured near the root of pin (see Figure 1).

# SJPX-H6

### **Derating Curves**

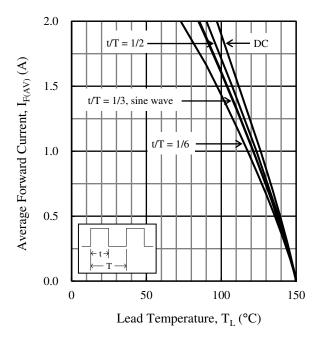


Figure 2.  $I_{F(AV)}$  vs.  $T_L$  ( $T_J = 150 \text{ °C}$ ,  $V_R = 0 \text{ V}$ )

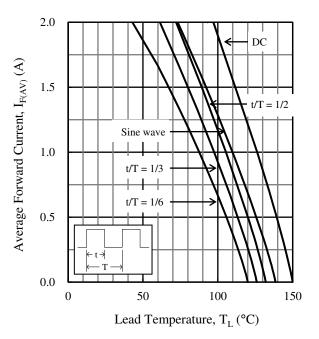


Figure 3.  $I_{F(AV)}$  vs.  $T_L (T_J = 150 \text{ °C}, V_R = 600 \text{ V})$ 

### **Characteristic Curves**

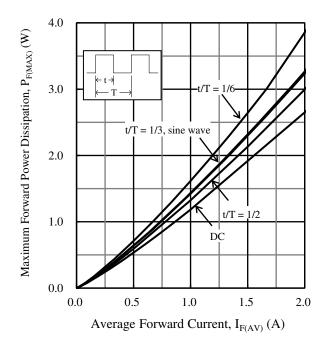


Figure 4.  $P_{F(MAX)}$  vs.  $I_{F(AV)}$  (T<sub>J</sub> = 150 °C)

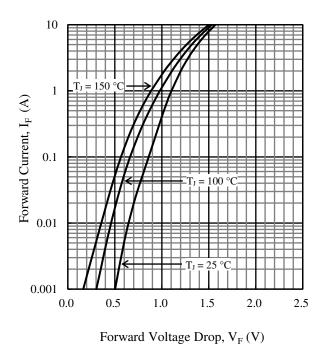


Figure 6. Typical Characteristics: IF vs. VF

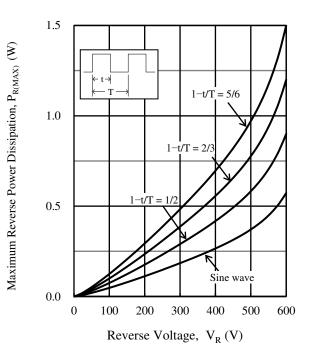


Figure 5.  $P_{R(MAX)}$  vs.  $V_R$  ( $T_J = 150 \ ^{\circ}C$ )

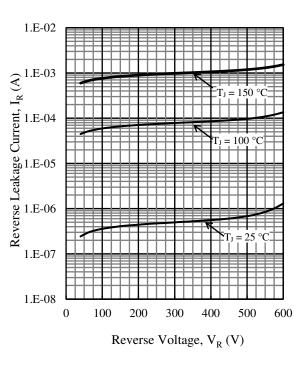


Figure 7. Typical Characteristics: I<sub>R</sub> vs. V<sub>R</sub>

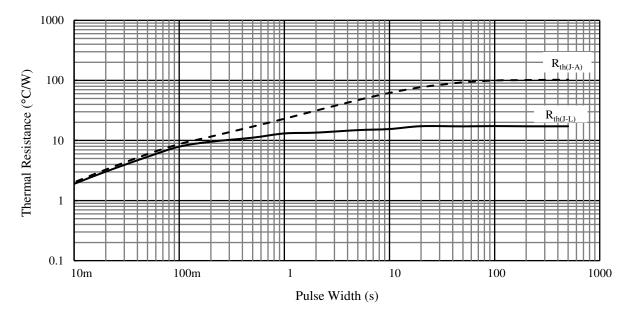
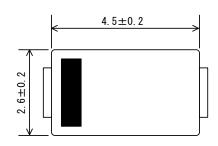
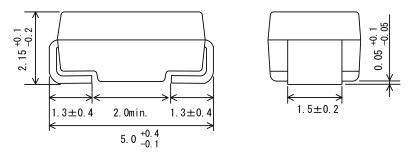


Figure 8. Typical Transient Thermal Resistance Characteristics

### **Physical Dimensions**

• SJP Package





#### NOTES:

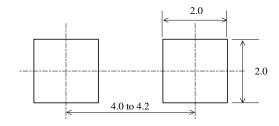
- Dimensions in millimeters
- Bare lead frame: Pb-free (RoHS compliant)
- Moisture Sensitivity Level 1 (MSL 1)
- When soldering the products, it is required to minimize the working time within the following limits:
- Flow: 260 °C / 10 s, 1 time Reflow:

Preheat: 150 °C to 200 °C / 60 s to 120 s

Solder heating: 255 °C / 30s, 3 times (260 °C peak)

- Soldering Iron: 350 °C / 3.5 s, 1 time

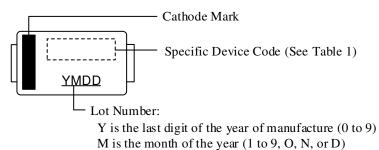
#### • SJP Land Pattern Example



#### NOTE:

- Dimensions in millimeters

## **Marking Diagram**



DD is the day of the month (01 to 31)

Table 1. Specific Device Code

Specific Device Code	Part Number
XH6	SJPX-H6

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